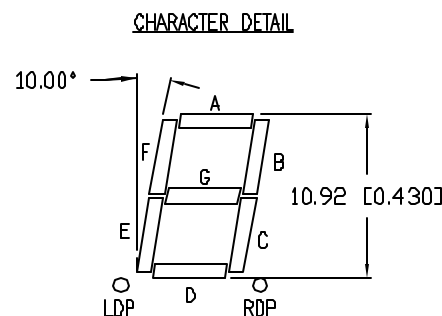
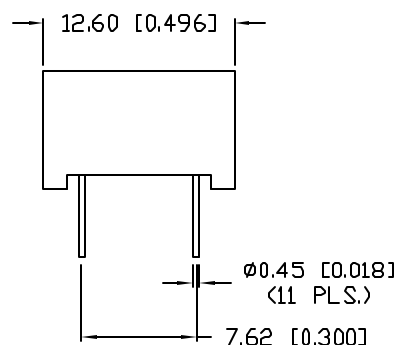
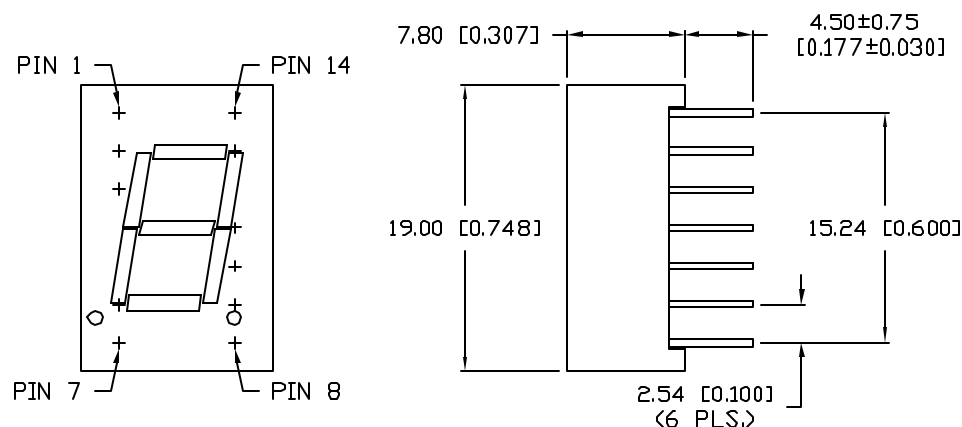


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PART NUMBER LDS-A416BI		REV.
REV.	E.C.N. NUMBER AND REVISION COMMENTS	DATE

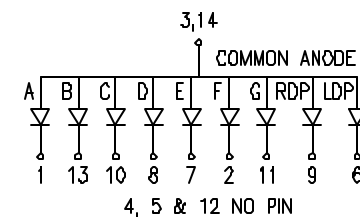


ELECTRO-OPTICAL CHARACTERISTICS $T_A=25^\circ\text{C}$ $I_f=10\text{mA}$					
PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		660 (RED)		nm	
FORWARD VOLTAGE		1.7	2.3	V_f	
REVERSE VOLTAGE	4.0			V_r	$I_r=100\mu\text{A}$
AXIAL INTENSITY		13000		μcd	$I_f=10\text{mA}$
EMITTED COLOR:	RED				
FACE COLOR:	GRAY				
SEGMENT COLOR:	MILKY WHITE DIFFUSED				

LIMITS OF SAFE OPERATION AT 25°C PER CHIP

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	30	mA
POWER DISSIPATION	105	mW
DERATE FROM 25°C	-1.2	mW/ $^\circ\text{C}$
OPERATING, STORAGE TEMP.	-40 TO +85	$^\circ\text{C}$
SOLDERING TEMP.	+260	$^\circ\text{C}$
2.0mm FROM BODY	3 SEC. MAX	

* $t < 10\mu\text{s}$



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*UNLESS OTHERWISE SPECIFIED TOLERANCE IS $\pm 0.25\text{mm}$ ($\pm 0.010"$)

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0.43" SINGLE DIGIT, SEVEN SEGMENT DISPLAY, 660nm RED CHIPS, GRAY FACE WITH WHITE SEGMENTS, COMMON ANODE.			DRAWN BY: BC	CHECKED BY:	APPROVED BY:	DATE: 2-1-99 PAGE: 1 OF 1 SCALE: N/A